



Click [here](#) for the 3D model.

| Dimensions | |
|------------|-----------------|
| D | 12.5mm +/-0.5mm |
| L | 13.5mm +/-0.5mm |
| W | 1.25mm +/-0.2mm |
| F | 0.3mm MAX |
| A | 12.8mm +/-0.2mm |
| B | 12.8mm +/-0.2mm |
| C | 15.2mm MAX |
| E | 4.9mm +/-0.2mm |
| G | 1mm +/-0.2mm |
| P | 4.6mm +/-0.2mm |

| Packaging Specifications | |
|--------------------------|-----|
| Packaging | T&R |
| Packaging Quantity | 200 |

| General Information | |
|---------------------|--------------------------------------|
| Series | EDH |
| Dielectric | Aluminum Electrolytic |
| Style | SMD Can |
| Description | Surface Mount, Aluminum Electrolytic |
| RoHS | Yes |
| Lead | V-Chip |
| AEC-Q200 | No |

| Specifications | |
|-------------------------|------------------------|
| Capacitance | 470 uF |
| Capacitance Tolerance | 20% |
| Voltage DC | 35 VDC, 44 VDC (Surge) |
| Temperature Range | -40/+105°C |
| Rated Temperature | 105°C |
| Life | 2000 Hrs |
| Dissipation Factor | 22% 120Hz 20C |
| Ripple Current | 520 mAmps (120Hz 105C) |
| Leakage Current | 164.5 uA (2min 20°C) |
| Impedance Ratio at -25C | 2 |
| Impedance Ratio at -40C | 3 |
| High Temperature Solder | Yes |